

## TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

ETAS ID: TM516503

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT		
<b>NATURE OF CONVEYANCE:</b>	RELEASE OF SECURITY INTEREST		
<b>CONVEYING PARTY DATA</b>			
<b>Name</b>	<b>Formerly</b>	<b>Execution Date</b>	<b>Entity Type</b>
JPMorgan Chase Bank, N.A.		03/29/2019	National Banking Association: UNITED STATES
<b>RECEIVING PARTY DATA</b>			
<b>Name:</b>	Integrated Device Technology, Inc.		
<b>Street Address:</b>	6024 Silver Creek Valley Road		
<b>City:</b>	San Jose		
<b>State/Country:</b>	CALIFORNIA		
<b>Postal Code:</b>	95138		
<b>Entity Type:</b>	Corporation: DELAWARE		
<b>Name:</b>	GigPeak, Inc.		
<b>Street Address:</b>	130 Baytech Drive		
<b>City:</b>	San Jose		
<b>State/Country:</b>	CALIFORNIA		
<b>Postal Code:</b>	95134		
<b>Entity Type:</b>	Corporation: DELAWARE		
<b>Name:</b>	ChipX, Incorporated		
<b>Street Address:</b>	130 Baytech Drive		
<b>City:</b>	San Jose		
<b>State/Country:</b>	CALIFORNIA		
<b>Postal Code:</b>	95134		
<b>Entity Type:</b>	Corporation: DELAWARE		
<b>Name:</b>	Endwave Corporation		
<b>Street Address:</b>	130 Baytech Drive		
<b>City:</b>	San Jose		
<b>State/Country:</b>	CALIFORNIA		
<b>Postal Code:</b>	95134		
<b>Entity Type:</b>	Corporation: DELAWARE		
<b>Name:</b>	Magnum Semiconductor, Inc.		
<b>Street Address:</b>	130 Baytech Drive		
<b>City:</b>	San Jose		

CH \$540.00 3017903

<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95134
<b>Entity Type:</b>	Corporation: DELAWARE

**PROPERTY NUMBERS Total: 21**

Property Type	Number	Word Mark
Registration Number:	3017903	VERSACLOCK
Registration Number:	3507953	
Registration Number:	1555550	INTEGRATED DEVICE TECHNOLOGY
Registration Number:	3623895	XPRESSO
Registration Number:	3424144	XPRESSO
Registration Number:	3299179	XPRESSO
Registration Number:	3442358	XPRESSO FOX
Registration Number:	4822559	XPRESSO-ULTRA
Registration Number:	4956210	ULTRA
Registration Number:	2498981	HIPERCLOCKS
Registration Number:	2854123	TERACLOCK
Registration Number:	2684179	TERASYNC
Registration Number:	2893618	IDT
Registration Number:	3159809	IDT
Serial Number:	86957649	TOUCH THE CLOUD
Serial Number:	86957614	GIGPEAK
Serial Number:	86957673	G
Serial Number:	86957655	GIGCLOUD
Registration Number:	3805344	MAGNUM SEMICONDUCTOR
Registration Number:	3261924	CHIP·X
Registration Number:	2496013	ENDWAVE

**CORRESPONDENCE DATA**

**Fax Number:** 7037607777

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

**Phone:** 7037607360

**Email:** hcheng@mofo.com

**Correspondent Name:** Hsiao-Ting Cheng

**Address Line 1:** 1650 Tysons Boulevard, Suite 400

**Address Line 2:** Morrison & Foerster LLP

**Address Line 4:** McLean, VIRGINIA 22102

**ATTORNEY DOCKET NUMBER:** 69008-27

**NAME OF SUBMITTER:** Jeffrey Xu

<b>SIGNATURE:</b>	/Jeffrey Xu/
<b>DATE SIGNED:</b>	03/29/2019
<b>Total Attachments: 7</b> source=IDT- Trademark Release-721475#page1.tif source=IDT- Trademark Release-721475#page2.tif source=IDT- Trademark Release-721475#page3.tif source=IDT- Trademark Release-721475#page4.tif source=IDT- Trademark Release-721475#page5.tif source=IDT- Trademark Release-721475#page6.tif source=IDT- Trademark Release-721475#page7.tif	

## **RELEASE OF SECURITY INTEREST IN TRADEMARKS**

This RELEASE OF SECURITY INTEREST IN TRADEMARKS (this “Release”), dated as of March 29, 2019 (the “Effective Date”), is made by JPMorgan Chase Bank, N.A., in its capacity as Administrative Agent and Collateral Agent (in each such capacity, the “Agent”), in favor of Integrated Device Technology, Inc., GigPeak, Inc., ChipX, Incorporated, Endwave Corporation and Magnum Semiconductor, Inc. (collectively, the “Grantors”, and, individually each a “Grantor”).

WHEREAS, pursuant to that certain Security Agreement, dated as of April 4, 2017, by and among the Agent, the Grantors and certain other parties thereto (as amended, restated, amended and restated, supplemented or otherwise modified from time to time, the “Security Agreement”), the Grantors granted to the Agent, in its capacity as Agent, a security interest in and to certain collateral;

WHEREAS, pursuant to the Security Agreement, the Borrower and the Grantors executed and delivered Trademark Security Agreement, dated as of April 4, 2017 (the “Trademark Security Agreement”), for recordal with the United States Patent and Trademark Office;

WHEREAS, the Trademark Security Agreement was recorded with the United States Patent and Trademark Office on April 4, 2017 at Reel/Frame 6028/0358;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the Agent hereby agrees as follows:

1. Defined Terms. All capitalized terms used, but not otherwise defined herein, shall have the respective meanings ascribed in or otherwise referenced in the Security Agreement or the Trademark Security Agreement, as applicable.
2. Release. The Agent, without representation or warranty of any kind, hereby releases, discharges, terminates and cancels all of its security interest in and to the Trademark Collateral, including the trademark registrations and applications set forth on Schedule I attached hereto, arising under the Security Agreement and the Trademark Security Agreement. If and to the extent that the Agent has acquired any right, title or interest in and to the Trademark Collateral under the Trademark Security Agreement, the Agent, without representation or warranty of any kind, hereby re-transfers, re-conveys and re-assigns such right, title or interest to the Grantors.
3. Termination. The Agent, without representation or warranty of any kind, terminates and cancels the Trademark Security Agreement.
4. Further Assurances. The Agent agrees to take all further actions, and provide to the Grantors and their respective successors, assigns or other legal representatives, all such cooperation and assistance (including, without limitation, the execution and delivery of any and all documents or other instruments), reasonably requested by the Grantors, at the Grantors’ sole cost and expense, to more fully and effectively effectuate the purposes of this Release.
5. Governing Law. This Release shall be governed exclusively under the laws of the State of New York, without regard to conflicts of law or choice of law principles.

*[Signature Pages to Follow]*

IN WITNESS WHEREOF, the Agent has caused this Release to be executed by its duly authorized representative as of the Effective Date:

**JPMORGAN CHASE BANK, N.A., acting in  
its capacity as Agent**

By: Caitlin Q Stewart  
Name: Caitlin Stewart  
Title: Executive Director








[Signature Page to Trademark Release]

**TRADEMARK**  
**REEL: 006604 FRAME: 0005**


# SCHEDULE I

Release of Trademark Security Agreement recorded April 4, 2017 at Reel/Frame 6028/0358


Mark Image	TM Registration Number	TM Registration Date	TM Application Number	TM Filing Date	Owner*	Class/Goods
VERSACLOCK	3017903	11/22/2005	78489273	9/24/2004	Integrated Device Technology, Inc.	IC 009, US 021 023 026 036 038
	3507953	9/30/2008	77401325	2/20/2008	Integrated Device Technology, Inc.	IC 009, US 021 023 026 036 038; IC 035, US 100 101 102; IC 038, US 100 101 104; IC 041, US 100 101 107; IC 042, US 100 101.
INTEGRATED DEVICE TECHNOLOGY	1555550	9/12/1989	73741286	7/21/1988	Integrated Device Technology, Inc.	IC 009, US 021 023 026 036 038
XPRESSO	3623895	5/19/2009	77331479	11/6/2007	Integrated Device Technology, Inc.	IC 009, US 021 023 026 036 038; IC 040, US 100 103 106
XPRESSO	3424144	5/6/2008	78617327	4/26/2005	Integrated Device Technology, Inc.	IC 009, US 021 023 026 036 038; IC 040, US 100 103 106
	3299179	9/25/2007	78658150	6/24/2005	Integrated Device Technology, Inc.	IC 009, US 021 023 026 036 038; IC 040, US 100 103 106
	3442358	6/3/2008	78658159	6/24/2005	Integrated Device Technology, Inc.	IC 009, US 021 023 026 036 038; IC 040, US 100 103 106

Mark Image	TM Registration Number	TM Registration Date	TM Application Number	TM Filing Date	Owner*	Class/Goods
	4822559	9/29/2015	85931722	5/14/2013	Integrated Device Technology, Inc.	IC 009. US 021 023 026 036 038; IC 040. US 100 103 106
	4956210	5/10/2016	85931961	5/14/2013	Integrated Device Technology, Inc.	IC 009. US 021 023 026 036 038; IC 040. US 100 103 106
	2498981	10/16/2001	75844653	11/9/1999	Integrated Device Technology, Inc.	IC 009. US 021 023 026 036 038
	2854123	6/15/2004	76007304	3/20/2000	Integrated Device Technology, Inc.	IC 009. US 021 023 026 036 038
	2684179	2/4/2003	76004852	3/20/2000	Integrated Device Technology, Inc.	IC 009. US 021 023 026 036 038
	2893618	10/12/2004	78321845	10/31/2003	Integrated Device Technology, Inc.	IC 009. US 021 023 026 036 038
	3159809	10/17/2006	78321842	10/31/2003	Integrated Device Technology, Inc.	IC 009. US 021 023 026 036 038

MARK	APP NO/ APPL DATE	REG NO/ REG. DATE	CLASS/GOO DS	OWNER*	STATUS
TOUCH THE CLOUD	8695764 9 March 30, 2016		9/semi- conductors; integrated circuits; integrated circuits, namely, system	GigOptix Inc.	May 15, 2017 - Deadline for filing a Statement of Use or 1 <sup>st</sup> extension

			on a chip		
GIGPEAK	8695761 4 March 30, 2016		9/semi-conductors; semi-conductor devices and computer software for processing and streaming audio and video signals; integrated circuits; integrated circuit cards and components; integrated circuits, namely, system on a chip	GigOptix Inc.	May 15, 2017 - Deadline for filing a Statement of Use or 1 <sup>st</sup> extension
	8695767 3 March 30, 2016		9/semi-conductors; semi-conductor devices and software for processing and streaming audio and video signals; integrated circuits; integrated circuit cards and components; system on a chip	GigOptix Inc.	January 28, 2017 – Response to office action due
GIGCLOUD	8695765 5 March 30, 2016		9/semi-conductors; semi-conductor devices and software for processing and streaming audio and video signals; integrated circuits;	GigOptix Inc.	January 27, 2017 – Response to office action due



			integrated circuit cards and components; system on a chip		
	7756727 7 September 10, 2008	380534 4 June 22, 2010	9/Computer software, firmware, and middleware for optical disc authoring and navigation, and for organizing, recording, formatting, and reading data and information for digital television broadcasting; codec chips, audio and video codec algorithms, encoders, video and audio decoders and computer disk drives.	Magnum Semiconductor, Inc.	Registered – Renewal due June 22, 2020  Unreleased security interest recorded on 4/6/2016 from Magnum Semiconductor, Inc to Silicon Valley Bank
CHIP-X	7838916 1 March 23, 2004	326192 4 July 10, 2007	9/Semiconductors; application specific integrated circuits and application specific integrated circuit layouts; computer software for use in customizing application specific integrated circuits and in manufacturing customized	ChipX, Incorporated	Registered – Renewal due July 10, 2017  Unreleased security interest recorded on 4/6/2016 from ChipX, Incorporated to Silicon Valley Bank

			integrated circuits and application specific integrated circuit layouts.		
ENDWAVE	7608484 7 July 7, 2000	249601 3 October 9, 2001	9/Broadband communication s components and assemblies for microwave and millimeterwave applications, namely, transceivers, comprised of antennas and transceivers, upconverters, downconverters amplifiers, mixers, oscillators	ENDWAVE CORPORATION	Renewed - Renewal due October 9, 2021  Unreleased amended and restated security interest recorded 4/7/2016 from ENDWAVE CORPORATION to Silicon Valley Bank